

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	((gate adj side adj air adj gap) and (carbon boron)) and (titanium tantalum vanadium zirconium iron chromium)) and (methane diborane)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 16:47
L2	4	((gate adj side adj air adj gap) and (carbon boron)) and (titanium tantalum vanadium zirconium iron chromium)) and hydrogen	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 16:47
L3	51	gate adj side adj air adj gap	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 16:47
L4	35	(gate adj side adj air adj gap) and (carbon boron)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 16:48
L5	18	((gate adj side adj air adj gap) and (carbon boron)) and (titanium tantalum vanadium zirconium iron chromium)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 16:49
L6	8	((gate adj side adj air adj gap) and (carbon boron)) and (titanium tantalum vanadium zirconium iron chromium)) and (void (air adj space))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 16:48
L7	14	("3510369" "4872947" "4895734" "4951601" "5011706" "5086014" "5242530" "5298597" "5360491" "5465680" "5468978" "5480300" "6054379" "6147009" "2002/0111042" "2003/0003765" "2003/0003768" "2003/0089988" "2003/0111730" "2003/0129827").PN.	USPAT	OR	ON	2005/02/06 16:49
L8	14	(substrate wafer) with (low adj "k") with (void via hole) with polish\$3	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 18:05
L9	10	((substrate wafer) with (low adj "k") with (void via hole) with polish\$3) and cvd	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 18:05
L10	10	((substrate wafer) with (low adj "k") with (void via hole) with polish\$3) and cvd) and cmp	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 18:07
L11	24	"5912187" "6322714" "6352934" "6399432" "6458646"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 18:05

L12	2	"6794293"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/06 18:07
L13	7	("6004883" "6204166" "6372635" "6376366" "6380073" "6429116" "6514860").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/06 18:09